Octal Bus Transceivers with 3-state Outputs

HITACHI

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Description

The HD74LV245A has eight buffers with three-state outputs in a 20-pin package. When DIR is high, data is transferred from the A inputs to the B outputs, and when DIR is low, data is transferred from the B inputs to the A outputs. The A and B buses are separated by making the enable input (\overline{OE}) high level. Low-voltage operation is suitable for battery-powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- $V_{CC} = 2.0 \text{ V to } 5.5 \text{ V operation}$
- All inputs V_{IH} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
- All outputs V_0 (Max.) = 5.5 V (@ V_{CC} = 0 V)
- Typical V_{OL} ground bounce < 0.8 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- Typical V_{OH} undershoot > 2.3 V (@ V_{CC} = 3.3 V, Ta = 25°C)
- Output current ± 8 mA (@V_{CC} = 3.0 V to 3.6 V), ± 16 mA (@V_{CC} = 4.5 V to 5.5 V)

Function Table

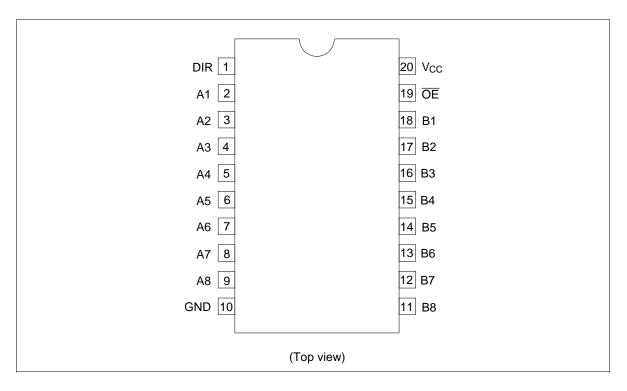
Inputs

ŌE	DIR	Operation
L	L	B data to A bus
L	Н	A data to B bus
Н	X	Isolation

Note: H: High level
L: Low level
X: Immaterial



Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V _{cc}	-0.5 to 7.0	V	
Input voltage range*1	Vı	-0.5 to 7.0	V	
Output voltage range*1, *2	Vo	-0.5 to V_{cc} + 0.5	V	Output: H or L
		-0.5 to 7.0	-	V _{cc} : OFF or Output: Z
Input clamp current	I _{IK}	-20	mA	V ₁ < 0
Output clamp current	I _{OK}	±50	mA	$V_{o} < 0 \text{ or } V_{o} > V_{cc}$
Continuous output current	Io	±35	mA	$V_{\rm O}$ = 0 to $V_{\rm CC}$
Continuous current through V _{cc} or GND	I _{CC} or I _{GND}	±70	mA	
Maximum power dissipation at Ta = 25°C (in still air)*3	P _T	835	mW	SOP
		757	-	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time..

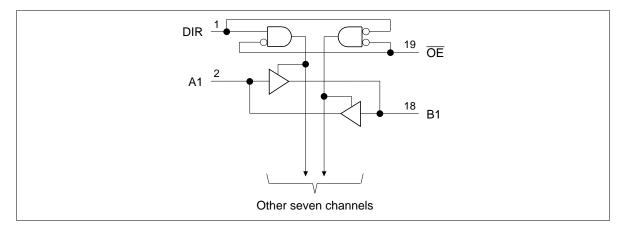
- 1. The input and output voltage ratings may be exceeded even if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The data above are measured by ΔV_{BE} method mounting on glass epoxy board (40 \times 40 \times 1.6 mm) with 10% of wiring density.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{cc}	2.0	5.5	V	
Input voltage range	V _I	0	5.5	V	
Output voltage range	Vo	0	V _{cc}	V	Output: H or L
		0	5.5		High impedance state
Output current	I _{OH}	_	-50	μΑ	V _{cc} = 2.0 V
		_	-2	mA	$V_{cc} = 2.3 \text{ to } 2.7 \text{ V}$
		_	-8		$V_{cc} = 3.0 \text{ to } 3.6 \text{ V}$
		_	-16		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
	I _{OL}	_	50	μΑ	V _{cc} = 2.0 V
		_	2	mA	$V_{cc} = 2.3 \text{ to } 2.7 \text{ V}$
		_	8		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	16		$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Input transition rise or fall rate	Δt /Δν	0	200	ns/V	$V_{CC} = 2.3 \text{ to } 2.7 \text{ V}$
		0	100		$V_{cc} = 3.0 \text{ to } 3.6 \text{ V}$
		0	20		$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Logic Diagram



DC Electrical Characteristics

• $Ta = -40 \text{ to } 85^{\circ}C$

Item	Symbol	V _{CC} (V)*1	Min	Тур	Max	Unit	Test Conditions
Input voltage	V _{IH}	2.0	1.5	_	_	V	
		2.3 to 2.7	$V_{CC} \times 0.7$	_	_		
		3.0 to 3.6	$V_{CC} \times 0.7$	_	_	_	
		4.5 to 5.5	$V_{CC} \times 0.7$	_	_	_	
	V _{IL}	2.0	_	_	0.5	_	
		2.3 to 2.7	_	_	$V_{\text{CC}}\!\times\!0.3$	_	
		3.0 to 3.6	_	_	$V_{CC} \times 0.3$	_	
		4.5 to 5.5	_	_	$V_{CC} \times 0.3$	_	
Output voltage	V _{OH}	Min to Max	V _{CC} -0.1	_	_	V	I _{OH} = -50 μA
		2.3	2.0	_	_	-	I _{OH} = -2 mA
		3.0	2.48	_	_	-	$I_{OH} = -8 \text{ mA}$
		4.5	3.8	_	_	-	I _{OH} = -16 mA
	V _{OL}	Min to Max	_	_	0.1	_	I _{OL} = 50 μA
		2.3	_	_	0.4	_	I _{OL} = 2 mA
		3.0	_	_	0.44	-	I _{OL} = 8 mA
		4.5	_	_	0.55	-	I _{OL} = 16 mA
Input current	I _{IN}	0 to 5.5	_	_	±1	μΑ	V _{IN} = 5.5 V or GND
Off-state output current	l _{OZ} *2	5.5	_	_	±5	μА	$V_O = V_{CC}$ or GND
Quiescent supply current	I _{cc}	5.5	_	_	20	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
Output leakage current	l _{OFF}	0	_	_	5	μΑ	V _O = 5.5 V
Input capacitance	C _{IN}	3.3	_	3.0	_	pF	$V_1 = V_{CC}$ or GND
Output capacitance	Со	3.3	_	5.5	_	pF	$V_0 = V_{CC}$ or GND

Notes: 1. For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

^{2.} For I/O ports, the parameter $\rm I_{\rm OZ}$ includes the input leakage current.

Switching Characteristics

• $V_{CC} = 2.5 \pm 0.2 \text{ V}$

		Ta = 25°C		Ta = -4	Ta = −40 to 85°C					
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH} t _{PHL}	_	8.3	13.0	1.0	15.0	ns	C _L = 15 pF	A or B	B or A
		_	11.2	15.9	1.0	18.0		C _L = 50 pF		
Enable time	t _{zH} t _{zL}	_	11.8	19.9	1.0	22.0	ns	C _L = 15 pF	ŌĒ	A or B
		_	14.1	22.7	1.0	26.0	=	C _L = 50 pF	_	
Disable time	t _{HZ} t _{LZ}	_	11.8	18.1	1.0	20.0	ns	C _L = 15 pF	ŌĒ	A or B

25.0

 $C_L = 50 pF$

17.6 23.1

1.0

• $V_{CC} = 3.3 \pm 0.3 \text{ V}$

		Ta =	25°C		Ta = −40 to 85°C		_			
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH} t _{PHL}	_	5.9	8.4	1.0	10.0	ns	$C_L = 15 pF$ A or B B		B or A
		_	7.9	11.9	1.0	13.5		C _L = 50 pF		
Enable time	t _{zH} t _{zL}	_	8.2	13.2	1.0	15.5	ns	C _L = 15 pF	ŌĒ	A or B
		_	9.9	16.7	1.0	19.0	_	C _L = 50 pF	_	
Disable time	t _{HZ} t _{LZ}	_	9.6	16.5	1.0	19.5	ns $C_L = 15 \text{ pF}$		ŌĒ	A or B
		_	13.9	19.8	1.0	22.0	_	C _L = 50 pF		

Switching Characteristics (cont)

• $V_{CC} = 5.0 \pm 0.5 V$

		Ta =	25°C		Ta = -	40 to 85°C				
ltem	Symbol	Min	Тур	Max	Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Propagation delay time	t _{PLH} t _{PHL}	_	4.3	5.5	1.0	6.5	ns	C _L = 15 pF	A or B	B or A
		_	5.6	7.5	1.0	8.5	-	C _L = 50 pF	_	
Enable time	t _{zH} t _{zL}	_	5.7	8.5	1.0	10.0	ns	C _L = 15 pF	ŌĒ	A or B
		_	7.0	10.6	1.0	12.0	-	C _L = 50 pF	_	
Disable time	t _{HZ} t _{LZ}	_	7.8	12.8	1.0	14.2	ns	C _L = 15 pF	ŌĒ	A or B
		_	10.9	14.7	1.0	16.0	=	C _L = 50 pF	_	

Output-skew Characteristics

• $C_L = 50 pF$

			Ta = 25°C	Ta = 25° C			
Item	Symbol	V _{cc} (V)	Min	Max	Min	Max	Unit
Output skew	t _{sk (O)}	2.3 to 2.7	_	2.0	_	2.0	ns
		3.0 to 3.6	_	1.5	_	1.5	
		4.5 to 5.5	_	1.0	_	1.0	

Note: Skew between any outputs of the me package switching in the same direction. This parameter is warranted but not production tested.

Operating Characteristics

• $C_L = 50 \text{ pF}$

Ta = 25°C

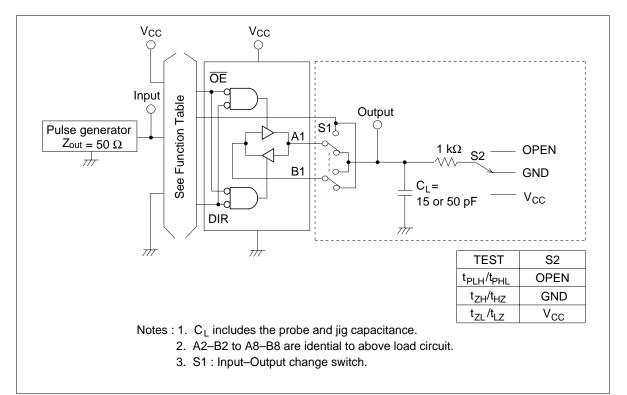
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	C_{\scriptscriptstylePD}	3.3	_	20.0	_	pF	f = 10 MHz
		5.0	_	25.0	_		

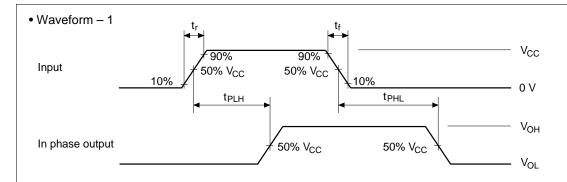
Noise Characteristics

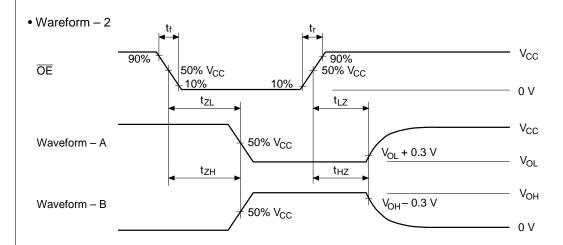
• $C_L = 50 pF$

			Ta = 25°	C			
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Unit	Test Conditions
Quiet output, maximum dynamic V _{OL}	$V_{OL(P)}$	3.3	_	0.5	0.8	V	
Quiet output, minimum dynamic V _{OL}	$V_{OL(V)}$	3.3	_	-0.4	-0.8		
Quiet output, minimum dynamic V _{OH}	$V_{OH(V)}$	3.3	_	2.9	_		
High-level dynamic input voltage	V _{IH (D)}	3.3	2.31	_	_	V	
Low level dynamic inout voltage	$V_{\text{IL}(D)}$	3.3	_	_	0.99		

Test Circuit



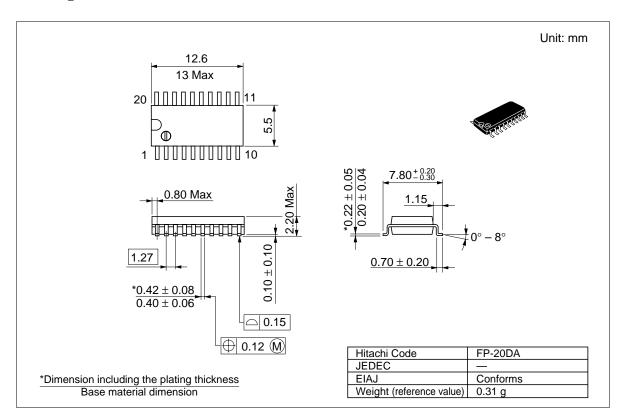


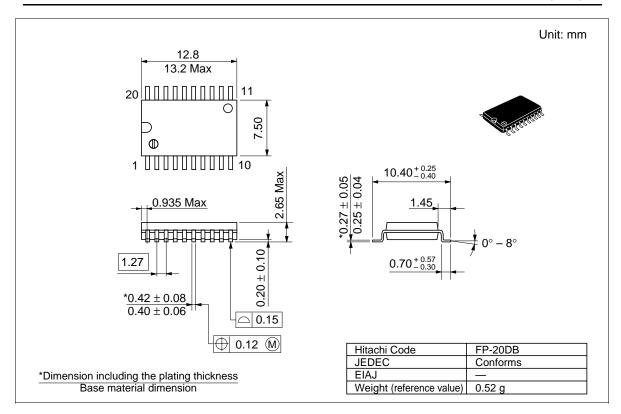


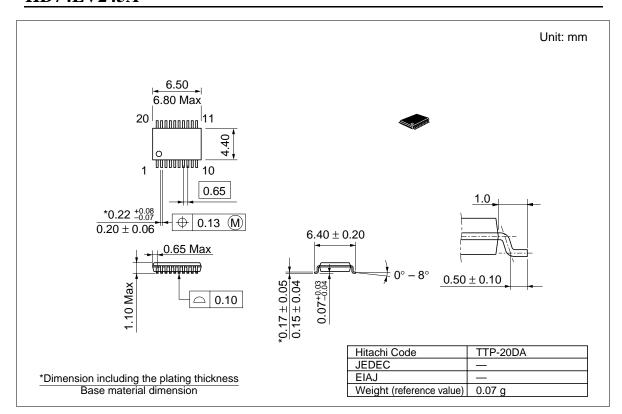
Notes: 1. Input waveform: PRR \leq 1 MHz, Zo = 50 $\Omega,\,t_{\rm f}\leq$ 3 ns, $t_{\rm f}\leq$ 3 ns

- 2. Waveform-A is for an output with internal conditions such that the output is low except when disabled by the output control.
- 3. Waveform-B is for an output with internal conditions such that the output is high except when disabled by the output control.
- 4. The output are measured one at a time with one transition per measurement.

Package Dimensions







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